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Electronic Patent Application Submission
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EFS ID: 49914
Application ID: 09912844
Title of Invention: HIGH PRESSURE PROCESSING
CHAMBER FOR SEMICONDUCTOR
SUBSTRATE
First Named Inventor: Maximilian Biberger
Domestic/Foreign Application: Domestic Application
Filing Date: 2001-07-24
Effective Receipt Date: 2003-10-29
Submission Type: Information Disclosure
Statement
Filing Type:
Confirmation number: 5915
Attorney Docket Number: NONE
Total Fees Authorized: 180.0
Payment Category: Deposit Account
Deposit Account Number: 81275
Deposit Account Name: Thomas B. Haverstock
Access Code: *****
RAM Payment Status: RAM success
RAM User ID: EFSPROD
RAM Accounting Date: 2003-10-29
RAM Sequence Number: 23




Digital Certificate Holder: cn=Thomas B. Haverstock,ou=Registered Attorneys,ou=Patent and
Trademark Office,ou=Department of Commerce,o=U.S. Government,c=US
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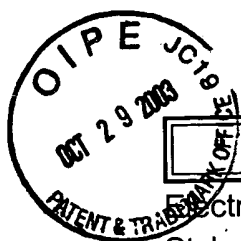
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Electronic Version v1.1


Stylesheet Version v1.1.0

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<table border="1"><thead><tr><th>Submitted by:</th><th>Elec. Sign.</th><th>Sign. Capacity</th></tr></thead><tbody><tr><td>Thomas B. Haverstock Registered Number: 32571</td><td>/tbh/</td><td>Attorney</td></tr></tbody></table>			Submitted by:	Elec. Sign.	Sign. Capacity	Thomas B. Haverstock Registered Number: 32571	/tbh/	Attorney								
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Comments

**FEE TRANSMITTAL**


Electronic Version v08
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Date: 2001-07-24											
First Named Applicant: Maximilian A. Biberger											
Attorney Docket Number:											
TOTAL FEE AUTHORIZED \$180											
Patent fees are subject to annual revisions on or about October 1st of each year.											
BASIC FILING FEE											
<table border="1"><thead><tr><th>Fee Description</th><th>Fee Code</th><th>Amount \$</th><th>Fee Paid \$</th></tr></thead><tbody><tr><td>Submission Of Information Disclosure Stmt Fee</td><td>1806</td><td>180</td><td>180</td></tr></tbody></table>				Fee Description	Fee Code	Amount \$	Fee Paid \$	Submission Of Information Disclosure Stmt Fee	1806	180	180
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Submission Of Information Disclosure Stmt Fee	1806	180	180								
AUTHORIZED BILLING INFORMATION The commissioner is hereby authorized to charge indicated fees and credit any overpayments to: Deposit account number: 081275 Access Code: **** Deposit name: Haverstock and Owens LLP Deposit authorized name: Thomas B. Haverstock Signature: /tbh/ Date (YYYYMMDD): 2003-10-29 Charge Any Additional Fee Required Under 37 C.F.R. Sections 1.16 and 1.17.											



ELECTRONIC INFORMATION DISCLOSURE STATEMENT

Electronic Version v18
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<div>Application Number: 09/912844 </div> <div>Confirmation Number: 5915</div> <div>First Named Applicant: Maximilian Biberger</div> <div>Attorney Docket Number:</div> <div>Search string: (2617719 or 2625886 or 3744660 or 3968885 or 4029517 or 4091643 or 4245154 or 4341592 or 4355937 or 4367140 or 4406596 or 4422651 or 4474199 or 4522788 or 4549467 or 4592306 or 4601181 or 4626509 or 4670126 or 4682937 or 4693777 or 4749440 or 4778356 or 4789077 or 4823976 or 4825808 or 4827867 or 4838476 or 4865061 or 4879431 or 4917556 or 4924892 or 4951601 or 4960140 or 4983223 or 5011542 or 5044871 or 5062770 or 5071485 or 5105556 or 5167716 or 5169296 or 5169408 or 5186718 or 5188515 or 5190373 or 5191993).pn.</div>																																																																																																	
<h3>US Patent Documents</h3> <p>Note: Applicant is not required to submit a paper copy of cited US Patent Documents</p> <table border="1"><thead><tr><th>init</th><th>Cite.No.</th><th>Patent No.</th><th>Date</th><th>Patentee</th><th>Kind</th><th>Class</th><th>Subclass</th></tr></thead><tbody><tr><td></td><td>1</td><td>2617719</td><td>1952-11-11</td><td>C. R. Stewart</td><td></td><td></td><td></td></tr><tr><td></td><td>2</td><td>2625886</td><td>1953-01-20</td><td>Browne</td><td></td><td></td><td></td></tr><tr><td></td><td>3</td><td>3744660</td><td>1973-07-10</td><td>Gaines et al.</td><td></td><td></td><td></td></tr><tr><td></td><td>4</td><td>3968885</td><td>1976-07-13</td><td>Hassan et al.</td><td></td><td></td><td></td></tr><tr><td></td><td>5</td><td>4029517</td><td>1977-06-14</td><td>Rand</td><td></td><td></td><td></td></tr><tr><td></td><td>6</td><td>4091643</td><td>1978-05-30</td><td>Zucchini</td><td></td><td></td><td></td></tr><tr><td></td><td>7</td><td>4245154</td><td>1981-01-13</td><td>Uehara et al.</td><td></td><td></td><td></td></tr><tr><td></td><td>8</td><td>4341592</td><td>1982-07-27</td><td>Shortes et al.</td><td></td><td></td><td></td></tr><tr><td></td><td>9</td><td>4355937</td><td>1982-10-26</td><td>Mack et al.</td><td></td><td></td><td></td></tr><tr><td></td><td>10</td><td>4367140</td><td>1983-01-04</td><td>Wilson</td><td></td><td></td><td></td></tr><tr><td></td><td>11</td><td>4406596</td><td>1983-09-27</td><td>Budde</td><td></td><td></td><td></td></tr></tbody></table>		init	Cite.No.	Patent No.	Date	Patentee	Kind	Class	Subclass		1	2617719	1952-11-11	C. R. Stewart					2	2625886	1953-01-20	Browne					3	3744660	1973-07-10	Gaines et al.					4	3968885	1976-07-13	Hassan et al.					5	4029517	1977-06-14	Rand					6	4091643	1978-05-30	Zucchini					7	4245154	1981-01-13	Uehara et al.					8	4341592	1982-07-27	Shortes et al.					9	4355937	1982-10-26	Mack et al.					10	4367140	1983-01-04	Wilson					11	4406596	1983-09-27	Budde			
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	46	5190373	1993-03-02	Dickson et al.
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Remarks

Note: Remarks are not for responding to an office action.

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Signature

Examiner Name	Date